



## SPECIFICATION

宏致電子股份有限公司

桃園縣中壢市東園路13號

No.13, Dongyuan Rd., Zhongli City,

Taoyuan County 320, Taiwan (R.O.C.)

TEL: +886-3-463-2808

FAX: +886-3-463-1800

**SPEC. NO.:** PS-50634-XXXXX-XXX      **REVISION:** C

**PRODUCT NAME:** 0.8 mm Pitch NON ZIF FPC Connector

**PRODUCT NO:** 50634/50635/50639/50640/50641      series

<b>PREPARED:</b>  <b>COCOYU</b>  <b>DATE:</b> <b>2015/07/14</b>	<b>CHECKED:</b>  <b>BRAVE</b>  <b>DATE:</b> <b>2015/07/14</b>	<b>APPROVED:</b>  <b>FRANK</b>  <b>DATE:</b> <b>2015/07/14</b>
--	--	---



TITLE: 0.5/1.0mm Pitch NON-ZIF FPC Conn. SMT R/A D/C Type

RELEASE DATE: 2015/07/14

REVISION: C

ECN No: ECN-1507163

PAGE: 2 OF 9

1	REVISION HISTORY .....	3
2	SCOPE .....	4
3	APPLICABLE DOCUMENTS.....	4
4	REQUIREMENTS .....	4
5	PERFORMANCE .....	5
6	INFRARED REFLOW CONDITION .....	7
7	PRODUCT QUALIFICATION AND TEST SEQUENCE.....	8
8	FPC Insertion/Extraction Force.....	9



Aces P/N: 50634/50635/50639/50640/50641 series

TITLE: 0.5/1.0mm Pitch NON-ZIF FPC Conn. SMT R/A D/C Type

RELEASE DATE: 2015/07/14

REVISION: C

ECN No: ECN-1507163

PAGE: 3 OF 9

## 1 Revision History

Rev.	ECN #	Revision Description	Approved	Date
O	ECN-0812063	1版發行	Jason Chen	2008.11.13
A	ECN-0902144	Amend SPEC TITLE	JASON	09/02/05
B	ECN-1401106	ADD Working voltage	JASON	14/01/09
C	ECN-1507163	ADD RETENTION FORCE	COCOYU	15/07/14

TITLE: 0.5/1.0mm Pitch NON-ZIF FPC Conn. SMT R/A D/C Type

RELEASE DATE: 2015/07/14

REVISION: C

ECN No: ECN-1507163

PAGE: 4 OF 9

## 2 SCOPE

This specification covers performance, tests and quality requirements for 0.8mm Pitch NON-ZIF FPC Connector.

Aces's P/N : 50634/50635series

## 3 APPLICABLE DOCUMENTS

EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

## 4 REQUIREMENTS

### 4.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable product drawing.

### 4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy.  
Finish: Plating pls. See the product drawing.
- 4.2.2 Housing: Thermoplastic High Temp., UL94V-0
- 4.2.3 Nut or Ear: Copper Alloy, Plating pls. See the product drawing.

### 4.3 Ratings

- 4.3.1 Working voltage less than 36 volts AC (per pin)
- 4.3.2 Voltage: 50 Volts AC (per pin)
- 4.3.3 Current: 0.5 Amperes (per pin)
- 4.3.4 Operating Temperature : -20°C to +85°C

TITLE: 0.5/1.0mm Pitch NON-ZIF FPC Conn. SMT R/A D/C Type

RELEASE DATE: 2015/07/14

REVISION: C

ECN No: ECN-1507163

PAGE: 5 OF 9

## 5 Performance

### 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
<b>ELECTRICAL</b>		
Item	Requirement	Standard
Low-signal Level Contact Resistance	20 m $\Omega$ Max. (initial)per contact 20 m $\Omega$ Max. Change allowed	Mate applicable FPC and measure by dry circuit, 20mV Max., 10mA Max. (EIA-364-23)
Insulation Resistance	50 M $\Omega$ Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	250 VAC Min. at sea level for 1 minute. No discharge, flashover or breakdown. Current leakage: 1 mA max.	Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current after:0.5 A/Power contact. The temperature rise above ambient shall not exceed 30°C The ambient condition is still air at 25°C (EIA-364-70 METHOD 2)
<b>MECHANICAL</b>		
Item	Requirement	Standard
Durability	20 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 $\pm$ 3mm/min. (EIA-364-09)
Contact Retention Force	0.3 kgf Min.	Operation Speed : 25.4 $\pm$ 3 mm/minute. Measure the contact retention force with Tensile strength tester.
<b>FPC Retention Force</b>	<b>0.05 kgf /Pin Min</b>	Insert the actuator, pull the FPC at the speed rate of 25.4 $\pm$ 3 mm/min.
Fitting Nail /Housing Retention Force	0.3 kgf MIN.	Apply axial pull out force at the speed rate of 25.4 $\pm$ 3 mm/minute. On the fitting nail assembled in the housing.

TITLE: 0.5/1.0mm Pitch NON-ZIF FPC Conn. SMT R/A D/C Type

RELEASE DATE: 2015/07/14

REVISION: C

ECN No: ECN-1507163

PAGE: 6 OF 9

Vibration	1 $\mu$ s Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 $\mu$ s Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

### ENVIRONMENTAL

Item	Requirement	Standard
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 9 (Lead Free)	Pre Heat : 150°C~180°C, 60~90sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max. See 6.1 Lead free process
Thermal Shock	See Product Qualification and Test Sequence Group 3	Mate module and subject to follow condition for 5 cycles. 1 cycles: -40 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition A)
Humidity	See Product Qualification and Test Sequence Group 3	Mated Connector 40°C, 90~95% RH, Reefer to Method II. (EIA-364-31, Test condition A)
Temperature life	See Product Qualification and Test Sequence Group 4	Subject mated connectors to temperature life at 85°C for 96 hours. Measure Signal. (EIA-364-17, Test condition A)

TITLE: 0.5/1.0mm Pitch NON-ZIF FPC Conn. SMT R/A D/C Type

RELEASE DATE: 2015/07/14

REVISION: C

ECN No: ECN-1507163

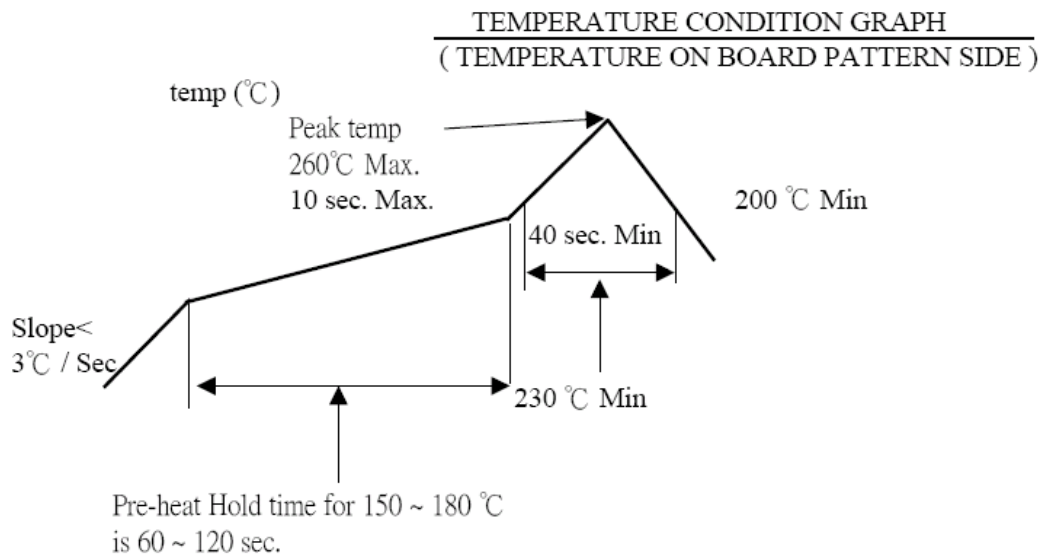
PAGE: 7 OF 9

Salt Spray	See Product Qualification and Test Sequence Group 5	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C for 8 hours. (EIA-364-26, Test condition B)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	Subject the test area of contacts into the flux for 5-10 sec. And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)
Hand Soldering	Hand Soldering temperature: 350±5°C (base on MIL-STD-202, method 208)	Contact Resistance: 40 mohms max.

**Note.** Flowing Mixed Gas shall be conducted by customer request.

## 6 INFRARED REFLOW CONDITION

### 6.1. Lead-free Process



**(reflow 2 cycles)**

TITLE: 0.5/1.0mm Pitch NON-ZIF FPC Conn. SMT R/A D/C Type

RELEASE DATE: 2015/07/14

REVISION: C

ECN No: ECN-1507163

PAGE: 8 OF 9

## 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group									
	1	2	3	4	5	6	7	8	9	10
	Test Sequence									
Examination of Product	1、3	1、8	1、7	1、6	1、4				1	
Low-signal Level Contact Resistance		2、11	2、10	2、9	2、5				3	1、4
Insulation Resistance		3、10	3、9	3、8						
Dielectric Withstanding Voltage		4、9	4、8	4、7						
Temperature rise	2									
Durability		6								
Vibration										2
Shock (Mechanical)										3
Thermal Shock			5							
Humidity			6							
Temperature life				5						
Salt Spray					3					
Solder ability						1				
Contact Retention Force							1			
FPC Retention Force		5、7								
Fitting Nail /Housing Retention Force								1		
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	2	4	4	4	4